## EPE FOAM HOT MELT

## SW5050

**Application:** Good bonding property to EPE materials (i.e. foam, board), brings complete protection and buffering on finished products.

**Characteristics:** Excellent bonding property, fast curing with good thermal stability and temperature resistance. Minimal odor and smell.

## **Specification:**

Polymer basis	Ethylene-VInyl Acetate
Viscosity at 160 °c (mPa s)	8,000 - 9,000
Softening point	90 - 100 °c
Supply form	White transparent in granule
Application temperature	150 - 170 °c

**Packaging & Storage:** in 25 kg kraft bag. 40 bags/ pallet Shelf life of 24 months, in original package, cool and dry (15-35°C).

**Remarks:** All data indicated are characteristics represented as average values. Our technical data sheets are revised to represent the latest information. This edition is valid on the date of compilation.

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